



P-Channel Enhancement-Mode Vertical DMOS FET

Features

- Low threshold (-2.4V max.)
- ▶ High input impedance
- Low input capacitance (95pF typical)
- Fast switching speeds
- Low on-resistance
- Free from secondary breakdown
- Low input and output leakage

Applications

- ► Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- ▶ Telecom switches

General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

The Quad-Array package, 20-Lead SOW (WG), uses four independent DMOS transistors which provide four independent channels.

Ordering Information

Desire	Package	Options	Wafer / Die Options					
Device	TO-92	20-Lead SOW	NW (Die in wafer form)	NJ (Die on adhesive tape)	ND (Die in waffle pack)			
TP0604	TP0604N3-G	TP0604WG-G	TP2404NW	TP2404NJ	TP2404ND			

For packaged products, -G indicates package is RoHS compliant ('Green'). Devices in Wafer / Die form are RoHS compliant ('Green'). Refer to Die Specification VF24 for layout and dimensions.

Product Summary

Device	BV _{DSS} /BV _{DGS} (V)	R _{DS(ON)} (max) (Ω)	I _{D(ON)} (min) (A)	V _{GS(th)} (max) (V)
TP0604N3-G	40	2.0	2.0	2.4
TP0604WG-G	-40	2.0	-2.0	-2.4

Absolute Maximum Ratings

Parameter	Value								
Drain-to-source voltage	BV _{DSS}								
Drain-to-gate voltage	BV_{DGS}								
Gate-to-source voltage	±20V								
Operating and storage temperature	-55°C to +150°C								

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Product Marking

 SiTP
 YY = Year Sealed

 0 6 0 4
 WW = Week Sealed

 YYWW
 = "Green" Packaging

Package may or may not include the following marks: Si or

TO-92 (N3)

Pin Configurations







20-Lead SOW (WG)

Product Marking



Package may or may not include the following marks: Si or

20-Lead SOW (WG)

Thermal Characteristics

Package	I _D (continuous) [†] (A)	I _D (pulsed) (A)	Power Dissipation @T _A = 25°C (W)	θ _{jc} (°C/W)	θ _{ja} (°C/W)	† (A)	I _{DRM} (A)
TO-92	-0.43	-4.2	0.74	125	170	-0.43	-4.2
20-Lead SOW	-0.6	-2.0	1.50	-	84	-0.6	-2.0

Notes:

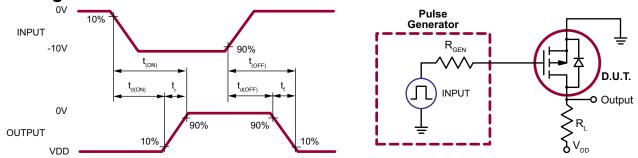
Electrical Characteristics (T_A = 25°C unless otherwise specified)

Sym	Parameter	Min	Тур	Max	Units	Conditions
BV _{DSS}	Drain-to-source breakdown voltage	-40	-	-	V	$V_{GS} = 0V, I_{D} = -2.0mA$
$V_{\rm GS(th)}$	Gate threshold voltage	-1.0	-	-2.4	V	$V_{GS} = V_{DS}$, $I_{D} = -1.0$ mA
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with temperature	-	-3.0	-4.5	mV/°C	$V_{GS} = V_{DS}$, $I_{D} = -1.0$ mA
l _{GSS}	Gate body leakage	-	-	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
		-	-	-10	μA	$V_{GS} = 0V, V_{DS} = Max Rating$
I _{DSS}	Zero gate voltage drain current	-	-	-1.0	mA	V_{DS} = 0.8 Max Rating, V_{GS} = 0V, T_{A} = 125°C
	ON-state drain current	-0.4	-0.6	-	Α	$V_{GS} = -5.0V, V_{DS} = -20V$
D(ON)	ON-State drain current		-3.3	-	_ ^	$V_{GS} = -10V, V_{DS} = -20V$
D	Static drain-to-source on-state resistance	-	2.0	3.5	Ω	$V_{GS} = -5.0V, I_{D} = -250mA$
R _{DS(ON)}	Static drain-to-source on-state resistance		1.5	2.0	32	$V_{GS} = -10V, I_{D} = -1.0A$
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with temperature	-	-	1.2	%/°C	$V_{GS} = -10V, I_{D} = -1.0A$
G _{FS}	Forward transductance	400	600	-	mmho	$V_{DS} = -20V, I_{D} = -1.0A$
C _{ISS}	Input capacitance	-	95	150		$V_{GS} = 0V$,
C _{oss}	Common source output capacitance	-	85	120	pF	$V_{DS} = -20V,$
C _{RSS}	Reverse transfer capacitance	-	35	60		f = 1.0MHz
t _{d(ON)}	Turn-on delay time	-	5.0	8.0		V - 20V
t _r	Rise time	-	7.0	18	20	$V_{DD} = -20V,$ $I_{D} = -1.0A,$
t _{d(OFF)}	Turn-off delay time		10	15	ns	$R_{GEN} = 25\Omega$
t	Fall time	-	6.0	19		GEN 2012
$V_{\scriptscriptstyle{SD}}$	Diode forward voltage drop	-	-1.3	-2.0	V	$V_{GS} = 0V, I_{SD} = -1.5A$
t _{rr}	Reverse recovery time	-	300	-	ns	$V_{GS} = 0V, I_{SD} = -1.5A$

Notes:

- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulsed test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

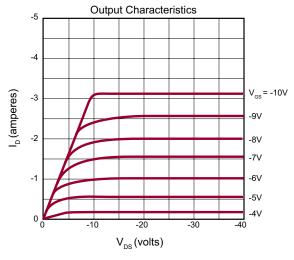
Switching Waveforms and Test Circuit

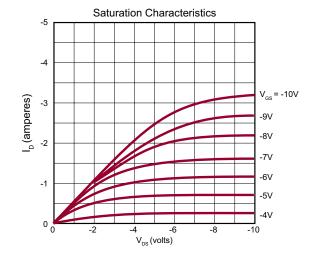


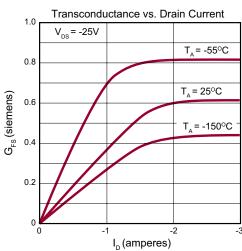
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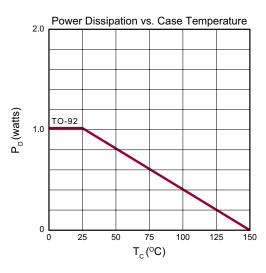
[†] I_D (continuous) is limited by max rated T_i .

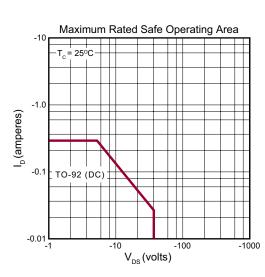
Typical Performance Curves

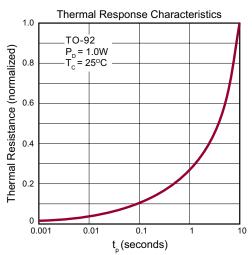




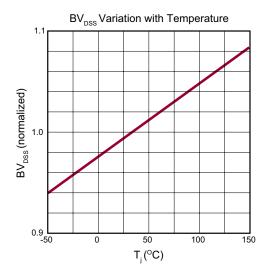


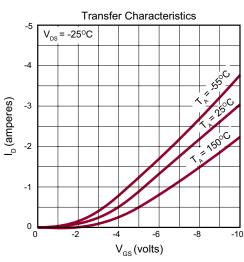


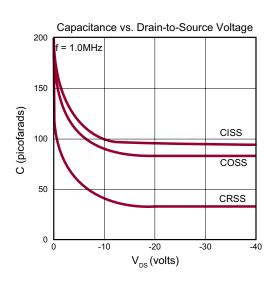


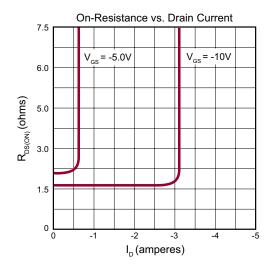


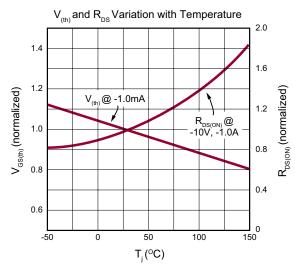
Typical Performance Curves (cont.)

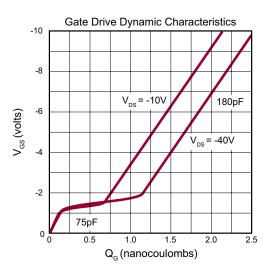




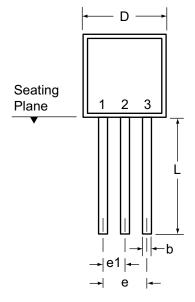


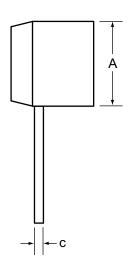






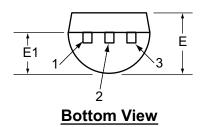
3-Lead TO-92 Package Outline (N3)





Front View

Side View



Symbol		Α	b	С	D	E	E1	е	e1	L
Dimensions (inches)	MIN	.170	.014 [†]	.014 [†]	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 [†]	.022 [†]	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

Drawings not to scale.

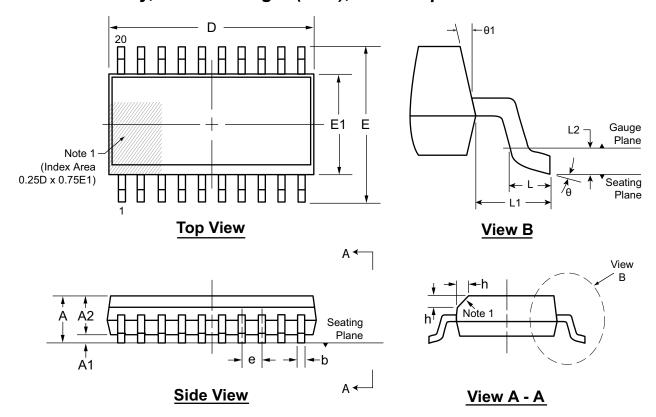
Supertex Doc.#: DSPD-3TO92N3, Version E041009.

^{*} This dimension is not specified in the JEDEC drawing.

[†] This dimension differs from the JEDEC drawing.

20-Lead SOW (Wide Body) Package Outline (WG)

12.80x7.50mm body, 2.65mm height (max), 1.27mm pitch



Note:

 A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol		Α	A1	A2	b	D	E	E1	е	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	2.15*	0.10	2.05	0.31	12.60*	9.97*	7.40*		0.25	0.40			0 º	5 °
	NOM	-	-	-	-	12.80	10.30	7.50	1.27 BSC	-	-	1.40 - REF	0.25 BSC	-	-
	MAX	2.65	0.30	2.55*	0.51	13.00*	10.63*	7.60*		0.75	1.27			8 0	15°

JEDEC Registration MS-013, Variation AC, Issue E, Sep. 2005.

* This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

Supertex Doc. #: DSPD-20SOWWG, Version D041309.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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